

PTO/SB/01 (8/95)

DECLARATION

Docket No. P56911

AS A BELOW NAMED INVENTOR, I hereby declare that:
My residence, post office address and citizenship are as stated next to my name.
I believe that I am the original, first and sole (if only one name is listed below), or an original, first and joint inventor (if plural names are listed below), of the subject matter which is claimed and for which a patent is sought on the invention entitled:

TITLE: **HOME ROBOT USING HOME SERVER, AND HOME NETWORK SYSTEM HAVING THE SAME**

the specification of which either is attached hereto or otherwise accompanies this Declaration, or:

☐ was filed in the U.S. Patent & Trademark Office on _____ and assigned Serial No. _____
☐ and (if applicable) was amended on _____

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability and to the examination of this application in accordance with Title 37 of the Code of Federal Regulations §1.56. I hereby claim foreign priority benefits under Title 35, U.S. Code §114(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, or §119(e) of any United States provisional application(s), listed below and have also identified below any foreign applications for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

70444/2002 (Application Number)	Republic of Korea (Country)	13 November 2002 (Day/Month/Year filed)	Yes [X] No []
_____ (Application Number)	_____ (Country)	_____ (Day/Month/Year filed)	Yes [] No []

I hereby claim the benefit under Title 35, U.S. Code, §120, of any United States application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application(s) in the manner provided by the first paragraph of Title 35, U.S. Code, §112. I acknowledge the duty to disclose information material to patentability as defined in Title 37, The Code of Federal Regulations, §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:

_____ (Application Serial No.)	_____ (Filing Date)	_____ (STATUS: patented, pending, abandoned)
_____ (Application Serial No.)	_____ (Filing Date)	_____ (STATUS: patented, pending, abandoned)

I hereby revoke all previously granted powers of attorney and appoint the following attorneys: Robert E. Bushnell, Reg. No. 27,774, Michael D. Parker, Reg. No. 34,973, and Saryadvinder Sahow, Reg. No. 47,051, to prosecute this application and to transact all business in the U.S. Patent & Trademark Office connected therewith and with any divisional, continuation, continuation-in-part, reissue or re-examination application, with full power of appointment and with full power to substitute an associate attorney or agent, and to receive all patents which may issue thereon, and request that all correspondence be addressed to:

Robert E. Bushnell,
Attorney-at-Law
Suite 300, 1522 "K" Street, N.W.
Washington, D.C. 20005-1202
Payor No. 008439
Area Code: 202-408-9040

I HEREBY DECLARE that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that those statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 U.S. Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF FIRST OR SOLE INVENTOR: HO-CHUL SHIN Citizenship: Republic of Korea

Inventor's signature: [Signature] Date: 2003/09/26
Residence & Post Office Address: 1032-3, Youngtong-dong, Paldal-gu, Suwon-city, Gyeonggi-do, Republic of Korea

FULL NAME OF SECOND JOINT INVENTOR: KYONG-JOON CHUN Citizenship: Republic of Korea

Inventor's signature: [Signature] Date: 9.26.2003
Residence & Post Office Address: 227-701, Olympic Kijachon Apt., Bangvi-dong, Songpa-gu, Seoul, Republic of Korea

FULL NAME OF THIRD JOINT INVENTOR: YOUNG-JIP KIM Citizenship: Republic of Korea

Inventor's signature: [Signature] Date: 2003.09.26
Residence & Post Office Address: 554-1003, Shinnamsil Jinheung Apt., Youngtong-dong, Paldal-gu, Suwon-city, Gyeonggi-do, Republic of Korea

FULL NAME OF FOURTH JOINT INVENTOR: BO-SEUNG HWANG Citizenship: Republic of Korea

Inventor's signature: [Signature] Date: 2003/09/26
Residence & Post Office Address: 1033-12, Youngtong-dong, Paldal-gu, Suwon-city, Gyeonggi-do, Republic of Korea

☐ Additional inventors are being named on separately numbered sheets attached hereto.

DECLARATION (Page Two)

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FULL NAME OF FIFTH OR SOLE INVENTOR: JAE-KIL LEE

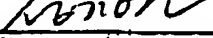
Citizenship: Republic of Korea

Inventor's signature: 
Residence & Post Office Address: 300-12, Haengdang 2-dong, Seongdong-gu, Seoul, Republic of Korea

Date: 2003-09-26

FULL NAME OF SIXTH JOINT INVENTOR: KI-YEON SUNG

Citizenship: Republic of Korea

Inventor's signature: 
Residence & Post Office Address: 1019-22, Yungtong-dong, Paldal-gu, Suwon-city, Gyeonggi-do, Republic of Korea

Date: 2003/09/26

FULL NAME OF SEVENTH JOINT INVENTOR: _____

Citizenship: _____

Inventor's signature: _____
Residence & Post Office Address: _____

Date: _____

FULL NAME OF EIGHTH JOINT INVENTOR: _____

Citizenship: _____

Inventor's signature: _____
Residence & Post Office Address: _____

Date: _____

FULL NAME OF NINTH OR SOLE INVENTOR: _____

Citizenship: _____

Inventor's signature: _____
Residence & Post Office Address: _____

Date: _____

FULL NAME OF TENTH JOINT INVENTOR: _____

Citizenship: _____

Inventor's signature: _____
Residence & Post Office Address: _____

Date: _____